February 1999



# NM93C56A 2,048-Bit Serial Interface, Standard Voltage CMOS EEPROM (MICROWIRE<sup>™</sup> Synchronous Bus)

# **General Description**

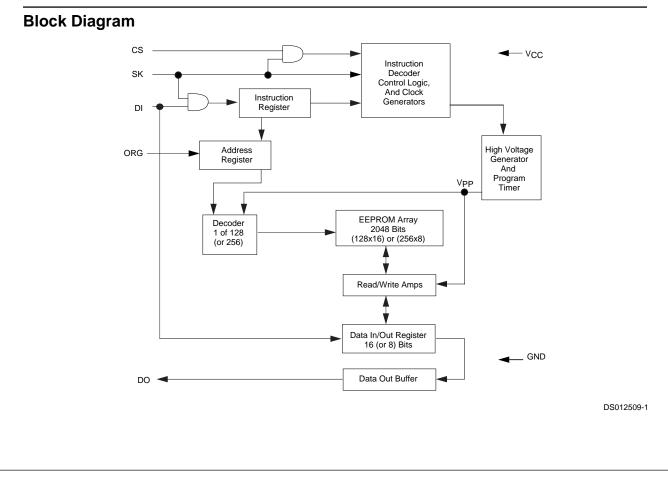
The NM93C56A is 2,048 bits of CMOS non-volatile, electrically erasable memory user organized as either 128 16-bit registers or 256 8-bit registers. The user organization is determined by the status of the ORG input. The memory device is fabricated using Fairchild Semiconductor's floating gate CMOS process for high reliability, high endurance and low power consumption. The NM93C56A is available in both 8-pin SO and TSSOP packages for space considerations.

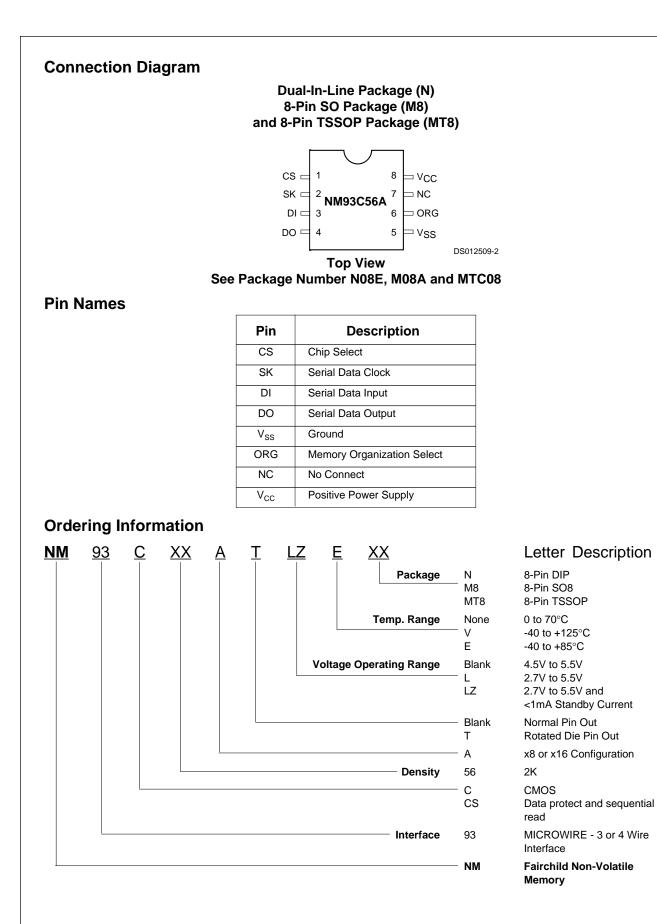
The EEPROM is MICROWIRE compatible for simple interfacing to a wide variety of microcontrollers and microprocessors. There are 7 instructions that operate the NM93C56A: Read, Erase/Write Enable, Erase, Write, Erase/Write Disable, Write All, and Erase All.

The NM93C56A defaults to the 128 x 16 configuration if the ORG pin (Pin 6) is left floating, as it is internally pulled up to  $V_{CC}$ .

## Features

- 2.7V to 5.5V operation in all modes
- Typical active current of 400 μA; typical standby current of 10 μA
- Self-timed programming cycle
- Device status indication during programming mode
- No erase required before write
- Reliable CMOS floating gate technology
- MICROWIRE compatible serial I/O
- 40 years data retention
- Endurance: 1,000,000 data changes
- Packages available: 8-Pin TSSOP, 8-pin SO, 8-pin DIP





# Absolute Maximum Ratings (Note 1)

Ambient Storage Temperature	-65°C to +150°C
All Input or Output Voltages with Respect to Ground	V <sub>CC</sub> +1 to -0.3V
Lead Temperature (Soldering, 10 seconds)	+300°C
ESD Rating	2000V

# **Operating Conditions**

Ambient Operating Temperature	
NM93C56A	0°C to +70°C
NM93C56AE	-40°C to +85°C
NM93C56AV	-40°C to +125°C
Power Supply ( $V_{CC}$ ) Range	2.7V to 5.5V

# DC and AC Electrical Characteristics $4.5V \le V_{CC} \le 5.5V$

Symbol	Parameter	Part Number	Conditions	Min	Max	Units mA	
I <sub>CCA</sub>	Operating Current		CS = V <sub>IH</sub> SK = 1 MHz		1		
I <sub>CCS</sub>	Standby Current		$CS = 0V ORG = V_{CC} or NC$		50	μΑ	
IIL	Input Leakage		$V_{IN} = 0V$ to $V_{CC}$ (Note 2)	-1	1	μΑ	
I <sub>ILO</sub>	Input Leakage ORG Pin		ORG Tied to $V_{CC}$ ORG Tied to $V_{SS}$ (Note 3)	-1 -2.5	1 2.5	μΑ	
I <sub>OL</sub>	Output Leakage		$V_{IN} = 0V$ to $V_{CC}$	-1	1	μΑ	
V <sub>IL</sub>	Input Low Voltage			-0.1	0.8	V	
V <sub>IH</sub>	Input High Voltage			2	V <sub>CC</sub> +1	V	
V <sub>OL1</sub>	Output Low Voltage		I <sub>OL</sub> = 2.1 mA		0.4	V	
V <sub>OH1</sub>	Output High Voltage		I <sub>OH</sub> = -400 μA	2.4		V	
V <sub>OL2</sub>	Output Low Voltage		I <sub>OL</sub> = 10 μA		0.2	V	
V <sub>OH2</sub>	Output High Voltage		I <sub>OL</sub> = -10 μA	V <sub>CC</sub> -0.2		V	
f <sub>sк</sub>	SK Clock Frequency		(Note 4)	0	1	MHz	
t <sub>SKH</sub>	SK High Time	NM93C56A NM93C56AE		250 300		ns	
t <sub>SKL</sub>	SK Low Time			250		ns	
t <sub>CS</sub>	Minimum CS Low Time		(Note 5)	250		ns	
t <sub>CSS</sub>	CS Set-Up Time			50		ns	
t <sub>DH</sub>	D0 Hold Time			70		ns	
t <sub>DIS</sub>	DI Set-Up Time	NM93C56A NM93C56AE/V		100 200		ns	
t <sub>CSH</sub>	CS Hold Time			0		ns	
t <sub>DIH</sub>	DI Hold Time			20		ns	
t <sub>PD1</sub>	Output Delay to "1"				500	ns	
t <sub>PD0</sub>	Output Delay to "0"				500	ns	
t <sub>SV</sub>	CS to Status Valid				500	ns	
t <sub>DF</sub>	CS to DO in TRI-STATE <sup>®</sup>				100	ns	
t <sub>WP</sub>	Write Cycle Time				10	ms	

## Absolute Maximum Ratings (Note 1)

ESD Rating

#### Ambient Storage Temperature -65°C to +150°C All Input or Output Voltage with Respect to Ground Lead Temperature (Soldering, 10 sec.)

+6.5V to -0.3V

+300°C

2000V

## **Operating Range**

Ambient Operating Temperature NM93C56AL NM93C56ALE NM93C56A LV Power Supply (V\_{CC})

0°C to +70°C -40°C to +85°C -40°C to +125°C 2.7V to 4.5V

# Low V<sub>CC</sub> (2.7V to 4.5V) DC and AC Electrical Characteristics

Symbol	Parameter Part Number Conditions		Conditions	Min.	Max.	Units	
I <sub>CCA</sub>	Operating Current		CS = V <sub>IH</sub> , SK = 250KHz		1	mA	
I <sub>CCS</sub>	Standby Current L LZ		CS = V <sub>IL</sub>		10 1	μA μA	
۱ <sub>IL</sub>	Input Leakage		$V_{IN} = 0V$ to $V_{CC}$ (Note 2)		±1	μA	
I <sub>ILO</sub>	Input Leakage ORG Pin		ORG tied to $V_{CC}$ ORG tied to $V_{SS}$ (Note 3)	-1 -2.5	1 2.5	μA	
I <sub>OL</sub>	Output Leakage		$V_{IN} = 0V$ to $V_{CC}$		±1	μA	
V <sub>IL</sub> V <sub>IH</sub>	Input Low Voltage Input High Voltage			-0.1 0.8 V <sub>CC</sub>	0.15 V <sub>CC</sub> V <sub>CC</sub> +1	V	
V <sub>OL</sub> V <sub>OH</sub>	Output Low Voltage Output High Voltage		I <sub>OL</sub> = 10 μA I <sub>OH</sub> = -10 μA	0.9 V <sub>CC</sub>	0.1 V <sub>CC</sub>	V V	
f <sub>sк</sub>	SK Clock Frequency		(Note 4)	0	250	KHz	
t <sub>SKH</sub>	SK High Time			1		μs	
t <sub>SKL</sub>	SK Low Time			1		μs	
t <sub>SKS</sub>	SK Setup Time		SK must be at $V_{IL}$ for $t_{SKS}$ before CS goes high	0.2		μs	
t <sub>cs</sub>	Minimum CS Low Time		(Note 5)	1		μs	
t <sub>CSS</sub>	CS Setup Time			0.2		μs	
t <sub>DH</sub>	DO Hold Time			70		ns	
t <sub>DIS</sub>	DI Setup Time			0.4		μs	
t <sub>CSH</sub>	CS Hold Time			0		μs	
t <sub>DIH</sub>	DI Hold Time			0.4		μs	
t <sub>PD1</sub>	Output Delay to "1"				2	μs	
t <sub>PD0</sub>	Output Delay to "0"				2	μs	
t <sub>SV</sub>	CS to Status Valid				1	μs	
t <sub>DF</sub>	CS to DO in TRI-STATE		CS = V <sub>IL</sub>		0.4	μs	
t <sub>WP</sub>	Write Cycle Time				15	ms	

# **Capacitance** $T_A = 25^{\circ}C$ , f = 1 MHz

Symbol	Test	Тур	Max	Units
C <sub>OUT</sub>	Output Capacitance		5	pF
C <sub>IN</sub>	Input Capacitance		5	pF

Note 1: Stress above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of the specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

Note 2: Typical leakage values are in the 20 nA range.

Note 3: The ORG pin may draw > 1  $\mu$ A when in the x8 mode ude to an internal pull-up transistor. Note 4: The shortest allowable SK clock period =  $1/f_{SK}$  (as shown under the  $f_{SK}$   $f_{SK}$  parameter). Maximum SK clock speed (minimum SK period) is determined by the interaction of several AC parameters stated in the datasheet. Within this SK period, both t<sub>SK4</sub> and t<sub>SK4</sub> limits must be observed. Therefore, it is not allowable to set  $1/f_{SK} = t_{SK4}$ -minimum + t<sub>SK4</sub>-minimum for shorter SK cycle time operation.

 $\label{eq:Note 5: CS (Chip Select) must be brought low (to V_L) for an interval of t_{CS} in order to reset all internal device registers (device reset) prior to beginning another opcode cycle. (This is shown in$ the opcode diagrams in the following pages.)

# **AC Test Conditions**

V <sub>CC</sub> Range	V <sub>IL</sub> /V <sub>IH</sub> Input Levels	V <sub>IL</sub> /V <sub>IH</sub> Timing Level	V <sub>OL</sub> /V <sub>OH</sub> Timing Level	I <sub>oL</sub> /I <sub>oH</sub>
$2.7V \le V_{CC} \le 5.5V$ (Extended Voltage Levels)	.03V/1.8V	1.0V	0.8V/1.5V	±10μA
$4.5V \le V_{CC} \le 5.5V$ (TTL Levels)	0.4V/2.4V	1.0V/2.0V	0.4V/2.4V	-2.1mA/0.4mA
	Output	t Load: 1 TTL Gate (C <sub>L</sub> = 1	00 pF)	·

# **MICROWIRE I/O Pin Description**

#### Chip Select (CS):

This pin enables and disables the MICROWIRE device and performs 3 general functions:

- 1. When in the low state, the MICROWIRE device is disabled and the output tri-stated (high impedance). If this pin is brought high (rising edge active), all internal registers are reset and the device is enabled, allowing MICROWIRE communication via DI/DO pins. To restate, the CS pin must be held high during all device communication and opcode functions. If the CS pin is brought low, all functions will be disabled and reset when CS is brought high again. The exception to this is when a programming cycle is initiated (see 2 and 3). Again, all activity on the CS, DI and DO pins is ignored until CS is brought high.
- 2. After entering all required opcode and address data, bringing CS low initiates the (asynchronous) programming cycle.
- 3. When programming is in progress, the Data-Out pin will display the programming status as either BUSY (DO low) or READY (DO high) when CS is brought high. (Again, the output will be tri-stated when CS is low.) To restate, during programming, the CS pin may be brought high and low any number of times to view the programming status without affect the programming operation. Once programming is completed (Output in READY state), the output is 'cleared' (returned to normal tri-state condition) by clocking in a Start Bit. After the Start Bit is clocked in, the output will return to a tri-stated condition. When clocked in, this Start Bit can be the first bit in a command string, or CS can be brought low again to reset all internal circuits.

## Instruction Set for the NM93C56A

Device	ORG	Memory			
	Pin Logic	Configuration # of Address Bits			
NM93C56A	0	256 x 8	9 Bits		
	1	128 x 16	8 Bits		

Note: For 93C56, the most significant bit becomes a "don't care."

#### Serial Clock (SK):

This pin is the clock input (rising edge active) for clocking in all opcodes and data on the DI pin and clocking out all data on the DO pin. However, this pin has no effect on the asynchronous programming cycle (see the CS pin section) as the BUSY/READY status is a function of the CS pin only.

#### Data-In (DI):

All serial communication into the device is performed using this input pin (rising edge active). In order to avoid false Start Bits, or related issues, it is advised to keep the DI pin in the low state unless actually clocking in data bits (Start Bit, Opcode, Address or incoming data bits to be programmed). Please note that the first '1' clocked into the device (after CS is brought high) is seen as a Start Bit and the beginning of a serial command string, so caution must be observed when bringing CS high.

#### Data-Out (DO):

All serial communication out of the device (READ opcode) is performed using this output pin (rising edge active) as well as indicating the READY/BUSY status duting the asynchronous programming cycle. Note that, during READ operations, the output data is clocked out after the last address bit (A0) is clocked in. If a 3-wire application is required (where DI and DO are tied together), sections in AN-758, or related application notes, must be followed for correct operation.

#### Organization (ORG):

This pin controls the device architecture (8-bit data word vs. 16-bit data word). If the ORG pin is brought to  $V_{CC}$ , the device is configured wiht a 16-bit data word and if the ORG pin is brought to  $V_{SS}$  (Ground), the device is configured with an 8-bit data word (refer to other sections for details of both configurations). If the ORG pin is left floating, the device will default to a 16-bit data word.

Instruction	SB	OP-Code 2 Bits	Address 8 Bits	Data 16 Bits	Comments
READ	1	10	A7–A0		Read data stored in selected registers.
EWEN	1	00	11XXXXX		Enables programming modes.
EWDS	1	00	00XXXXX		Disables all programming modes.
ERASE	1	11	A7–A0		Erase selected register.
WRITE	1	01	A7–A0	D15–D0	Writes data pattern D15–D0 into selected registers
ERAL	1	00	10XXXXX		Erases all registers.
WRAL	1	00	01XXXXX	D15–D0	Writes data pattern D15–D0 into all registers.

#### 128 by 16-Bit Organization (NM93C56A when ORG = V<sub>CC</sub> or NC)

Note: For 93C56, A7 becomes "don't care."

# **256 by 8-Bit Organization** (NM93C56A when ORG = GND)

Instruction	SB	OP-Code 2 Bits	Address 9 Bits	Data 8 Bits	Comments	
READ	1	10	A8–A0		Read data stored in selected registers.	
EWEN	1	00	11XXXXXX		Enables programming modes.	
EWDS	1	00	00XXXXXX		Disables all programming modes.	
ERASE	1	11	A8–A0		Erase selected register.	
WRITE	1	01	A8–A0	D7–D0	Writes data pattern D7–D0 into selected registers	
ERAL	1	00	10XXXXXX		Erases all registers.	
WRAL	1	00	01XXXXXX	D7–D0	Writes data pattern D7–D0 into all registers.	

Note: For 93C56, A8 becomes "don't care."

# **Functional Description**

#### **Programming:**

- Programming is initiated by clocking in the Start Bit, Opcode bits, Address bits and the 8/16 data bits (refer to the ORG pin section) As stated earlier, bringing CS low before the last data bit (DO) is clocked in will interrupt the proposed programming cycle.
- 2. Programming is started by bringing the CS pin low. Once the programming cycle is started, it cannot be stopped. (Bringing  $V_{CC}$  low will stop any programming, but will also result in data corruption.)
- 3. The status of the programming cycle (BUSY or READY) is observed by bringing the CS pin high and observing the output state. If the output is LOW, the device is still programming (BUSY). If the output is HIGH, the programming cycle has been completed and the device is ready for the next operation. Note that the output will be tri-stated each time CS is brought low and the R/B status will be shown each time CS is brought high.
- 4. The READY state (output HIGH) can be reset and the output tri-stated by clocking in a single Start Bit. This Start Bit can

be the first bit in a command string, or CS can be brought low again to reset all internal circuits. In any case, clocking in a '1' bit will tri-state the output.

#### Read (READ)

The READ instruction outputs serial data on the DO pin. After a READ instruction is received, the instruction and address are decoded, followed by data transfer from the selected memory register into a serial-out shift register. A dummy bit (logical 0) precedes the serial data output string. Output data changes are initiated by a low to high transition of SK after the last address bit (A0) is clocked in.

#### Erase/Write Enable (EWEN)

When V<sub>CC</sub> is applied to the part, it "powers up" in the Erase/Write Disable (EWDS) state. Therefore, all programming modes must be preceded by an Erase/Write Enable (EWEN) instruction. Once an Erase/Write Enable instruction is executed, programming remains enabled until an Erase/Write Disable (EWDS) instruction is executed or V<sub>CC</sub> is removed from the part.

# Functional Description (Continued)

#### Erase/Write Disable (EWDS):

To protect against accidental data overwrites, the Erase/Write Disable (EWDS) instruction disables all programming modes and should follow all programming operations. Execution of a READ instruction is independent of both the EWEN and EWDS instructions.

#### Erase (ERASE):

The ERASE instruction will program all bits in the specified register to the logical "1" state. Please refer to the Programming section for details.

#### Write (WRITE):

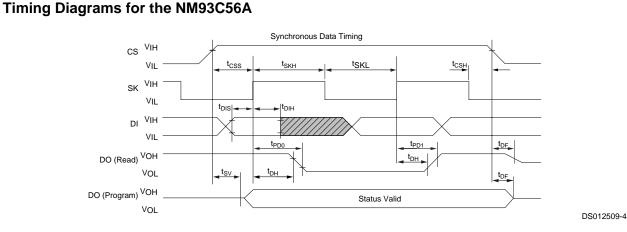
The WRITE instruction is followed by 16 bits of data (or 8 bits of data when using the NM93C56A in the x8 organization) to be written into the specified address. Please refer to the Programming section for details.

#### Erase All (ERAL):

The ERAL instruction will simultaneously program all registers in the memory array to the logical "1" state.

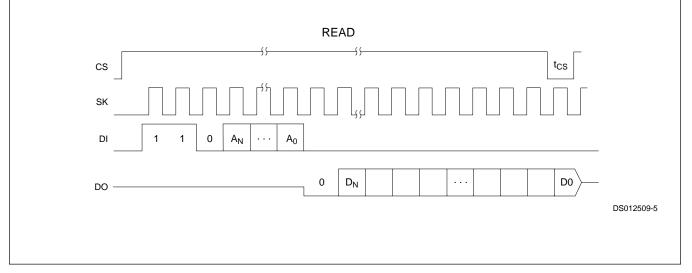
#### Write All (WRAL):

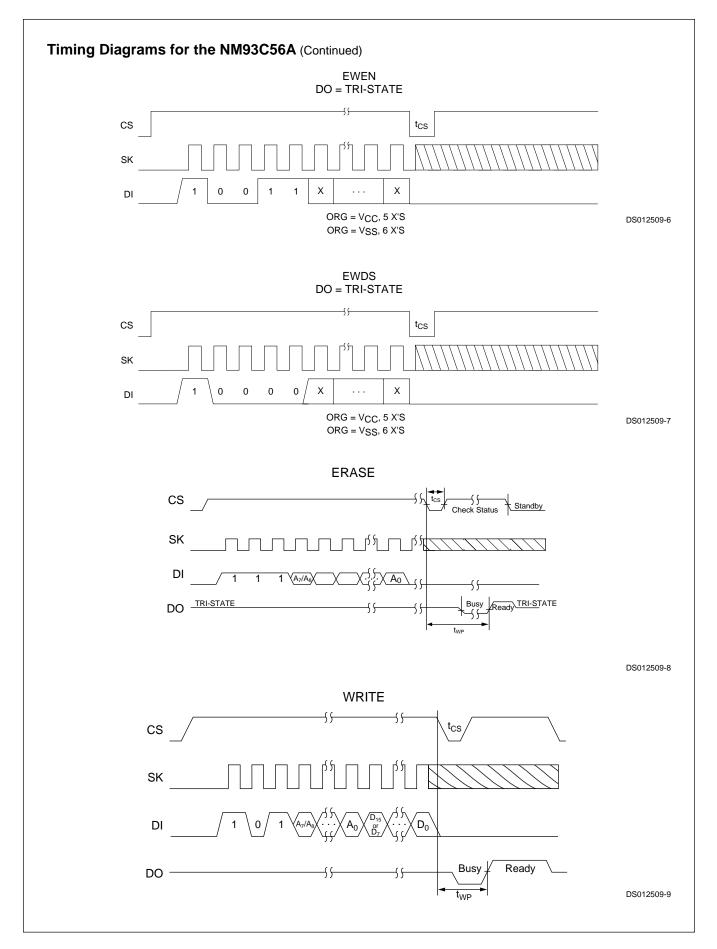
The WRAL instruction will simultaneously program all registers with the data pattern specified in the instruction.

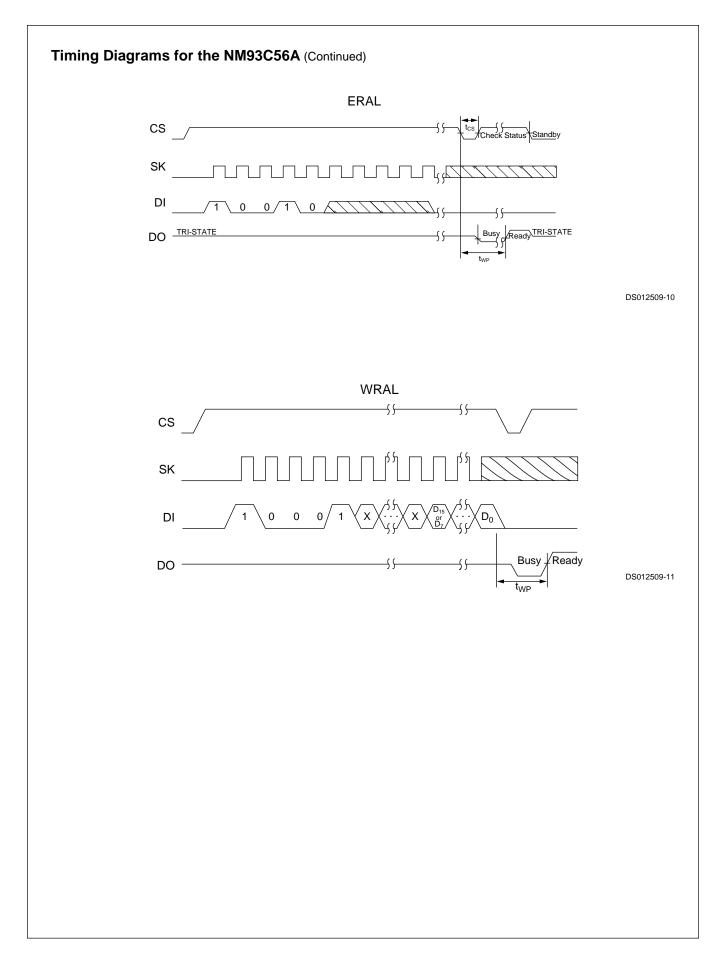


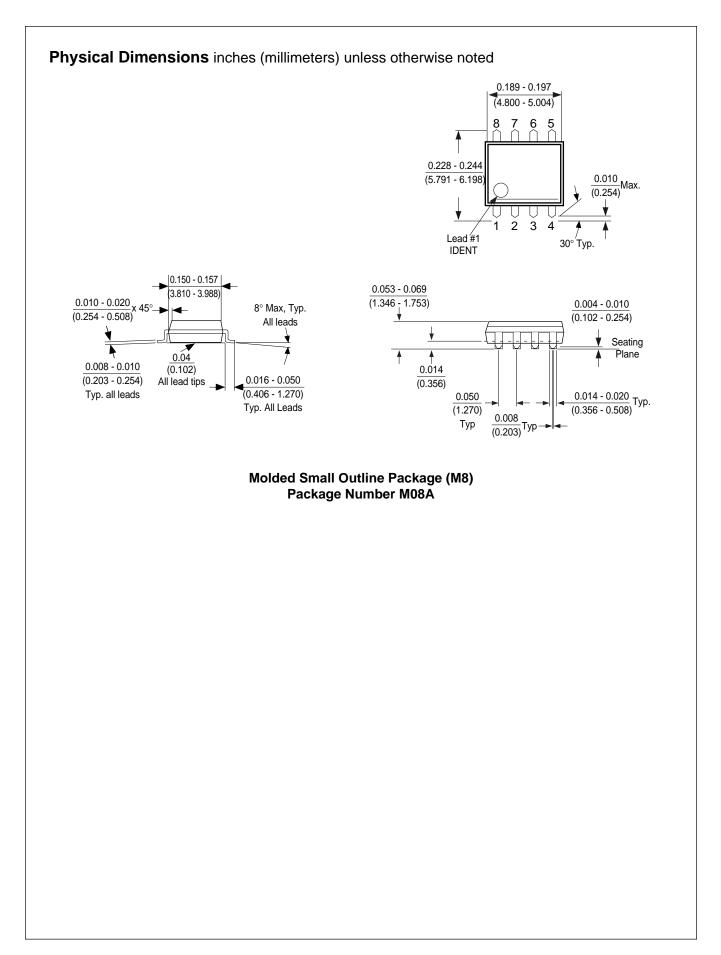
# Organization of Address and Data Fields for NM93C56A

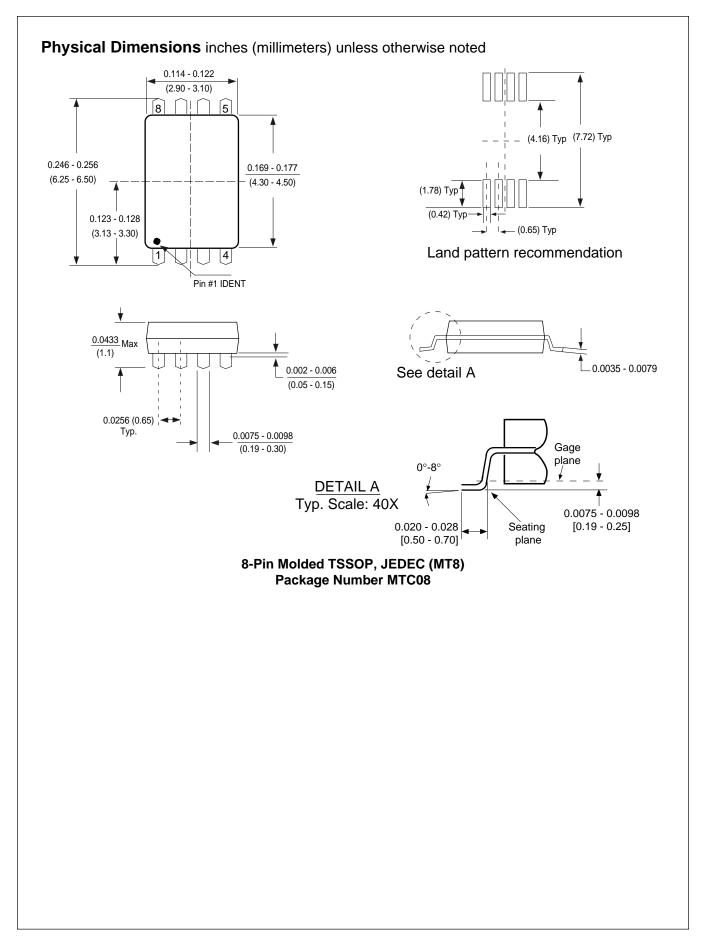
ORG Pin	Organization	A <sub>N</sub>	D <sub>N</sub>
V <sub>CC</sub> or NC	128 x 16	A7	D15
V <sub>SS</sub>	256 x 8	A8	D7

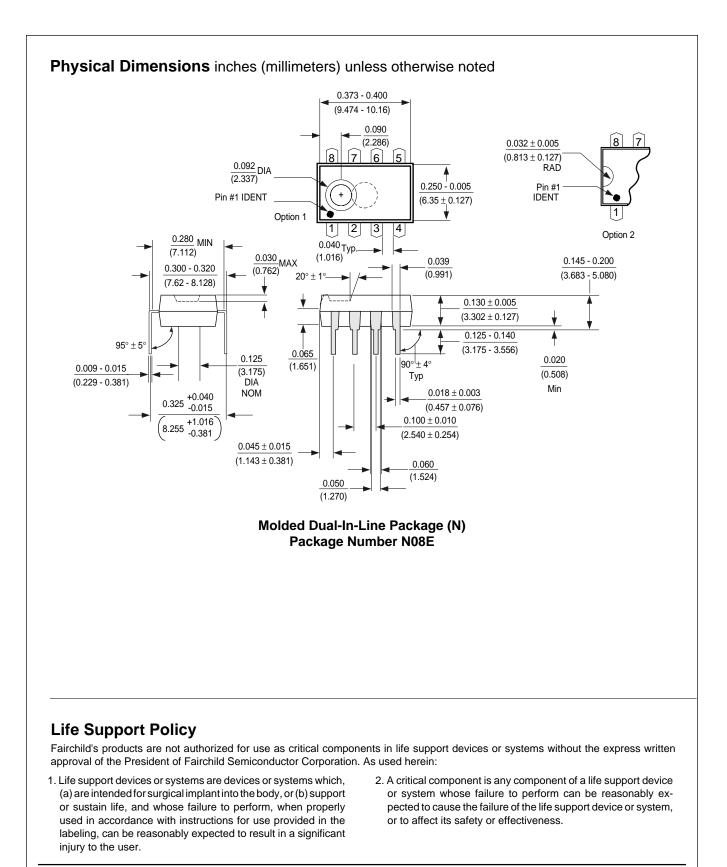












NM93C56A Rev. C.1

Fairchild Semiconductor

Tel. 1-888-522-5372

Americas Customer Response Center Fairchild Semiconductor

Kowloon. Hong Kong Tel; +852-2722-8338 Fax: +852-2722-8383

Hong Kong 8/F, Room 808, Empire Centre

68 Mody Road, Tsimshatsui East

Fairchild Semiconductor

Fax

Tel:

Tel: Tel: Tel: +44 (0) 1793-856858

+49 (0) 8141-6102-0

+44 (0) 1793-856856 +33 (0) 1-6930-3696 +39 (0) 2-249111-1

Europe

Deutsch

English Français Italiano Fairchild Semiconductor

Fairchild Semiconductor Japan Ltd. 4F, Natsume Bldg. 2-18-6, Yushima, Bunkyo-ku Tokyo, 113-0034 Japan Tel: 81-3-3818-8840 Fax: 81-3-3818-8841